

As helps named inventors, we hereby declare that:

Our residences, post office addresses and citizenships are as stated below next to our names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled CIRCUIT AND METHOD FOR TEST AND REPAIR, the specification of which:

is attached hereto.				
X	was filed on	5/24/01	, as Application Serial No.	09/864,682

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims.

We acknowledge the duty to disclose information which is material to patentability of the subject matter claimed in this application as "materiality" is defined in Title 37 of the Code of Federal Regulations, § 1.56.

We hereby claim the benefit of any earlier filing date in the United States to which we are entitled under Title 35 of the United States Code, § 120 and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 of the United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37 of the Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.)

(Filing Date)

(Status)

Send correspondence to:

Charles Brantley
Mail Stop 525
Micron Technology, Inc.
8000 S. Federal Way
Boise, Idaho 83716
(208) 368-4557

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first or sole inventor: Timothy B. Cowles

Inventor's Signature:

(First, Middle Initial, Last)

Date:

Residence Address:

13345 W. Woodspring Court

City, State, Country: Boise, ID 83713

United States of America

Citizenship:

US

Post Office Address:

Same as residence address

Full name of additional inventor:

Christian N. Mohr

Inventor's Signature:

(First, Middle Initial, Last)

Date:

8/18/01

Residence Address:

#2322 6600 Preston Road

City, State, Country:

Plano, TX 75024

United States of America

Citizenship:

US

Post Office Address:

Same as residence address